

PQ1CG3032FZ/ PQ1CG3032RZ

■ Features

1. Maximum switching current:3.5A
2. Built-in ON/OFF control function
3. Built-in soft start function to suppress overshoot of output voltage in power on sequence or ON/OFF control sequence
4. Built-in oscillation circuit
(Oscillation frequency:TYP. 150kHz)
5. Built-in overheat/overcurrent protection function
6. TO-220 package
7. Variable output voltage
(Output variable range: V_{ref} to $35V/-V_{ref}$ to $-30V$)
[Possible to select step-down output/inverting output according to external connection circuit]
8. **PQ1CG3032FZ**:Zigzag forming
PQ1CG3032RZ:Self-stand forming

■ Applications

1. CTV
2. Digital OA equipment
3. Facsimiles, printers and other OA equipment
4. Personal computers and amusement equipment

■ Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
*1 Input voltage	V_{IN}	40	V
Output adjustment terminal voltage	V_{ADJ}	7	V
Dropout voltage	V_{I-O}	41	V
*2 Output-COM voltage	V_{OUT}	-1	V
*3 ON/OFF control voltage	V_C	-0.3 to +40	V
Switching current	I_{SW}	3.5	A
*4 Power dissipation	P_{D1}	1.4	W
	P_{D2}	14	W
*5 Junction temperature	T_j	150	°C
Operating temperature	T_{opr}	-20 to +80	°C
Storage temperature	T_{stg}	-40 to +150	°C
*6 Soldering temperature	T_{sol}	260	°C

*1 Voltage between V_{IN} terminal and COM terminal

*2 Voltage between V_{OUT} terminal and COM terminal

*3 Voltage between ON/OFF control and COM terminal

*4 P_D : With infinite heat sink

*5 Over heat protection may operate at the condition $T_j=125^{\circ}\text{C}$ to 150°C

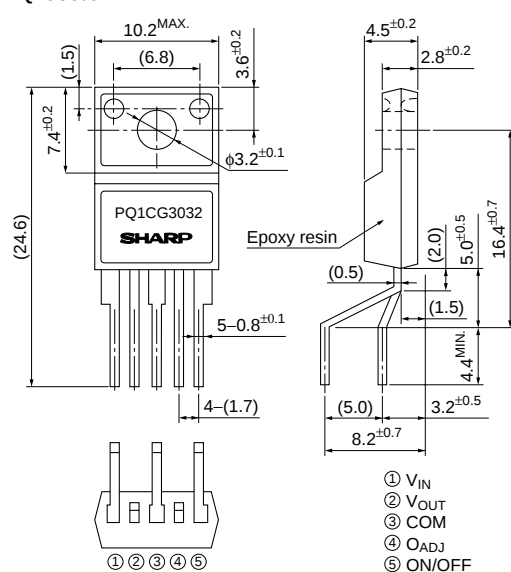
*6 For 10s

TO-220 Type Chopper Regulator

■ Outline Dimensions

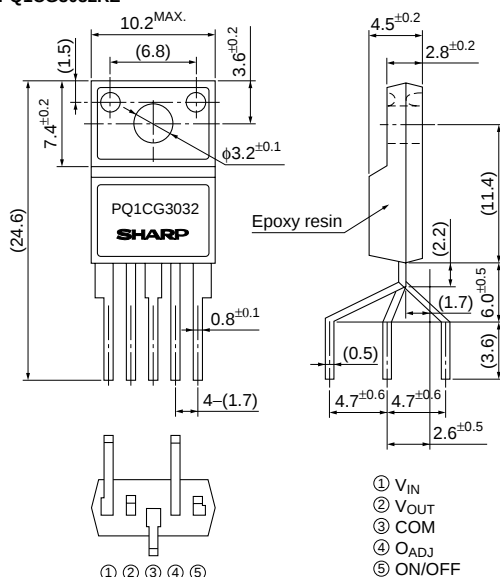
(Unit : mm)

PQ1CG3032FZ



* () : Typical dimensions

PQ1CG3032RZ



* () : Typical dimensions

■ Electrical Characteristics (Unless otherwise specified, condition shall be $V_{IN}=12V$, $I_O=0.5A$, $V_O=5V$, ON-OFF terminals is open, $T_a=25^{\circ}C$)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Output saturation voltage	V_{SAT}	$I_{SW}=3A$	—	1.4	1.8	V
Reference voltage	V_{ref}	—	1.235	1.26	1.285	V
Reference voltage temperature fluctuation	ΔV_{ref}	$T_J=0$ to $125^{\circ}C$	—	± 0.5	—	%
Load regulation	$ R_{regL} $	$I_O=0.5$ to $3A$	—	0.2	1.5	%
Line regulation	$ R_{regI} $	$V_{IN}=8$ to $35V$	—	1	2.5	%
Efficiency	η	$I_O=3A$	—	80	—	%
Oscillation frequency	f_o	—	135	150	165	kHz
Oscillation frequency temperature fluctuation	Δf_o	$T_J=0$ to $125^{\circ}C$	—	± 2	—	%
Overcurrent detecting level	I_L	—	3.6	4.7	5.8	A
Charge current	I_{CHG}	②, ④ terminals is open, ⑤ terminal	—	-10	—	μA
Threshold input voltage	V_{THL}	Duty ratio=0%, ④ terminal=0V, ⑤ terminal	—	1.3	—	V
	V_{THH}	Duty ratio=100%, ④ terminals is open, ⑤ terminal	—	2.3	—	V
ON threshold voltage	$V_{TH(ON)}$	④ terminal=0V, ⑤ terminal	0.7	0.8	0.9	V
Stand-by current	I_{SD}	$V_{IN}=40V$, ⑤ terminal=0V	—	140	400	μA
Output OFF-state consumption current	I_{QS}	$V_{IN}=40V$, ⑤ terminal=0.9V	—	8	16	mA

Fig.1 Standard Test Circuit

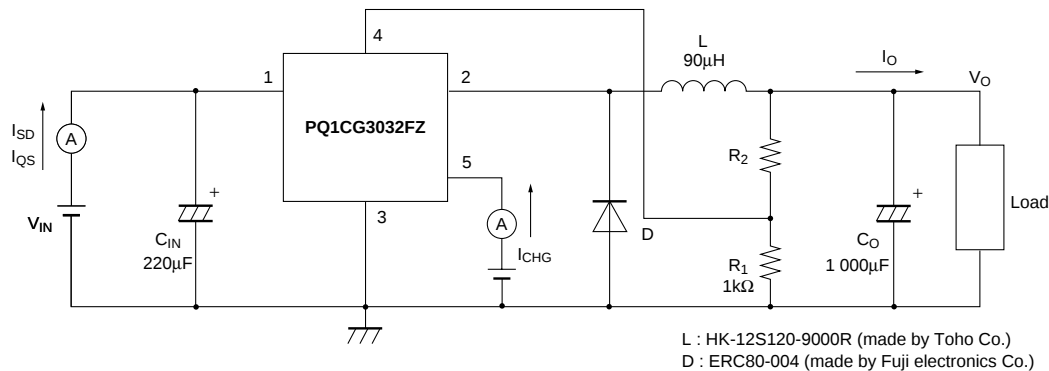


Fig.2 Power Dissipation vs. Ambient Temperature

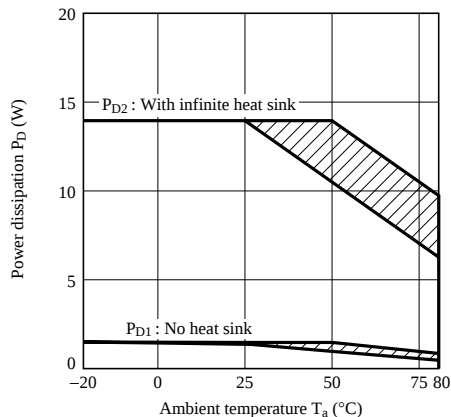


Fig.3 Overcurrent Protection Characteristics (Typical Value)

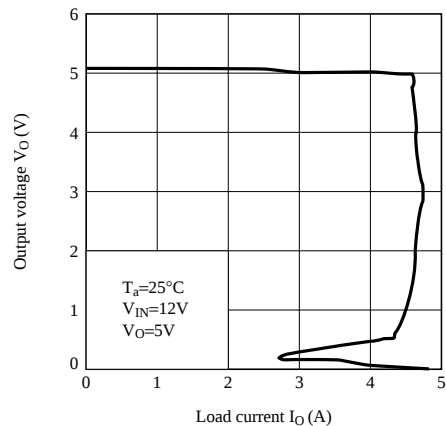


Fig.4 Efficiency vs. Input Voltage

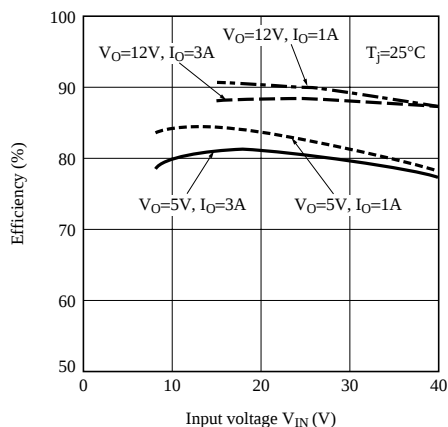


Fig.5 Output Saturation Voltage vs. Switching Current

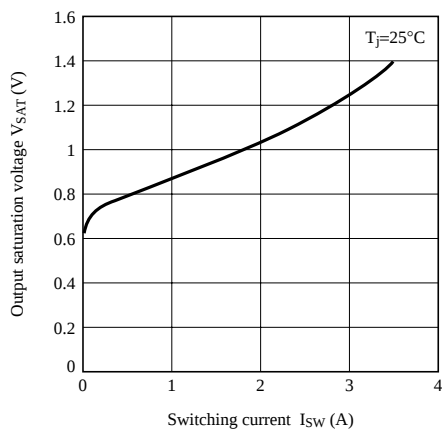


Fig.6 Stand by Current vs. Input Voltage

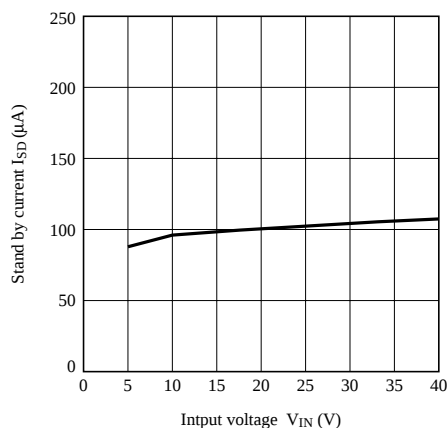


Fig.7 Reference Voltage Fluctuation vs. Junction Temperature

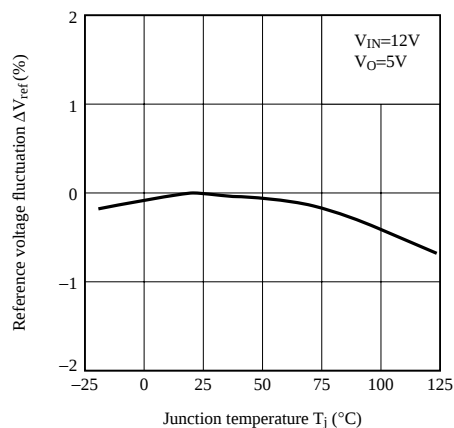


Fig.8 Load Regulation vs. Output Current

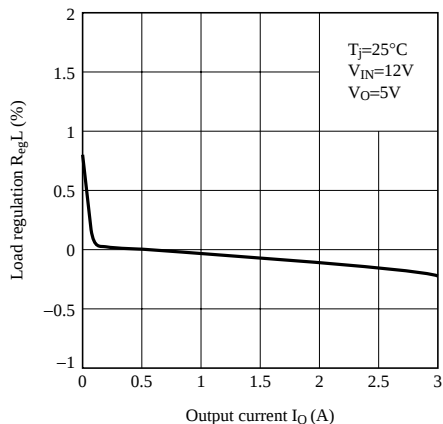


Fig.9 Line Regulation vs. Input Voltage

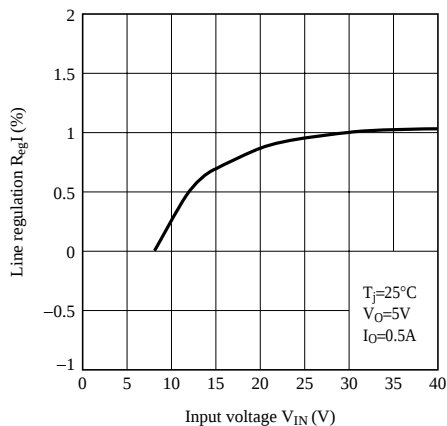


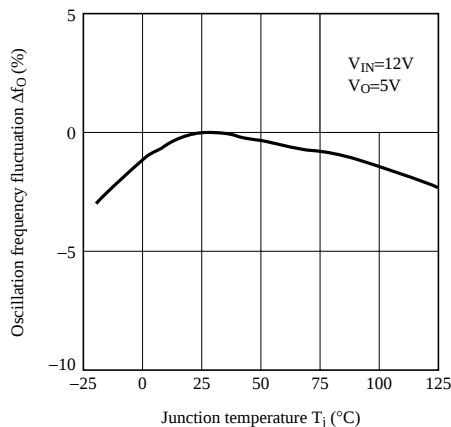
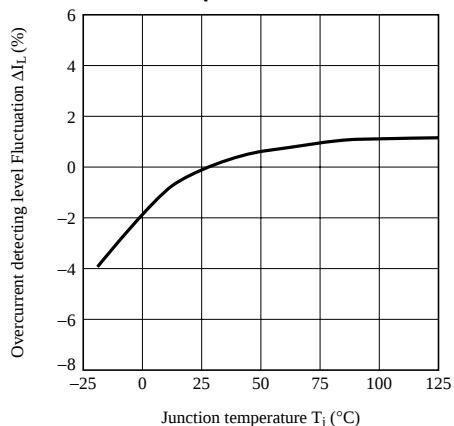
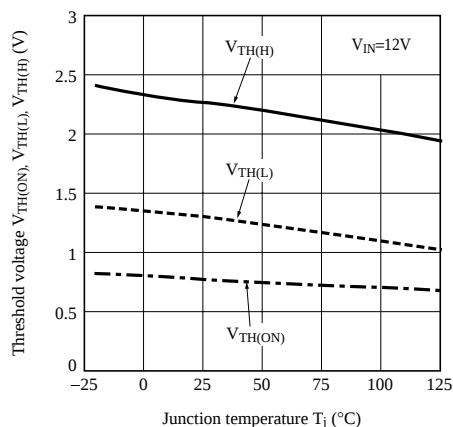
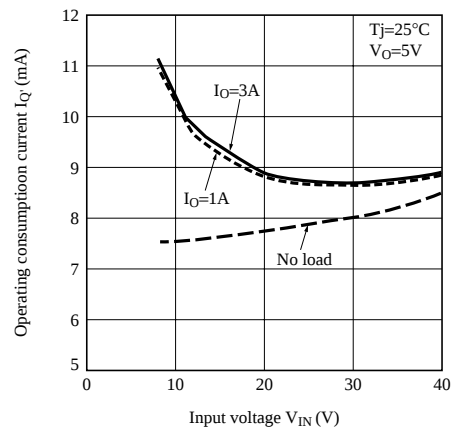
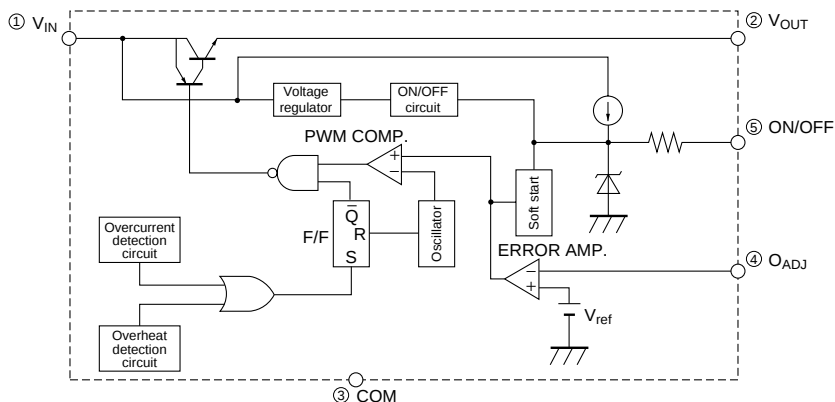
Fig.10 Oscillation Frequency Fluctuation vs. Junction Temperature**Fig.11 Overcurrent Detection Level Fluctuation vs. Junction Temperature****Fig.12 Threshold Voltage vs. Junction Temperature****Fig.13 Operating Consumption Current vs. Input Voltage****Fig.14 Block Diagram**

Fig.15 Step Down Type Circuit Diagram

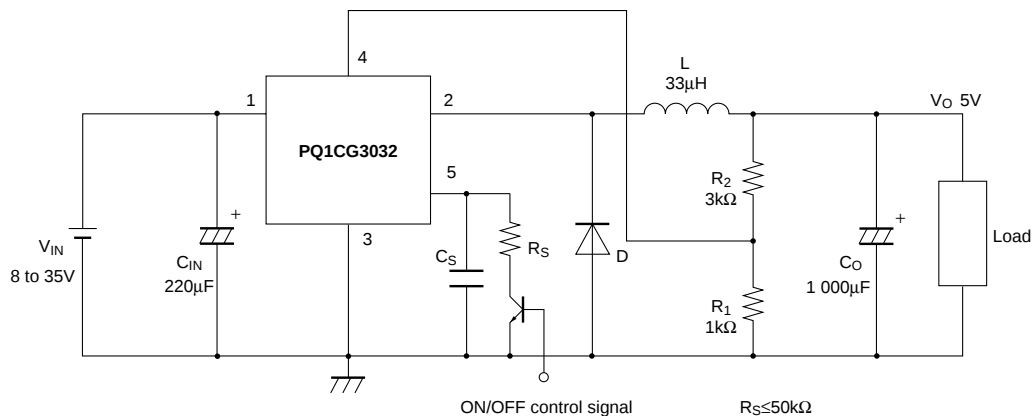
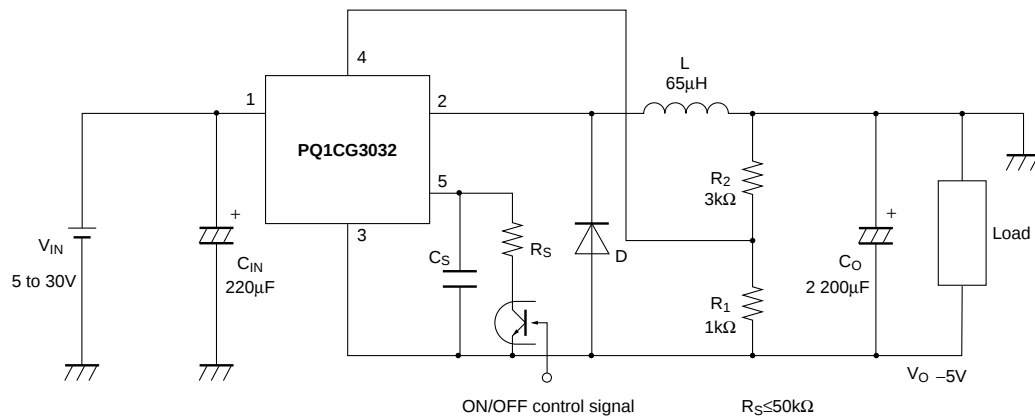
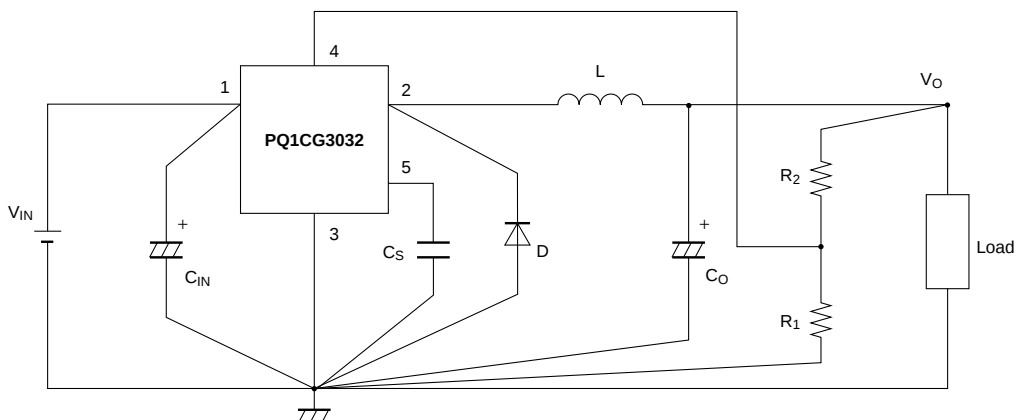


Fig.16 Polarity Inversion Type Circuit Diagram



■ Precautions for Use



1. External connection

- (1) Wiring condition is very important. Noise associated with wiring inductance may cause problems.

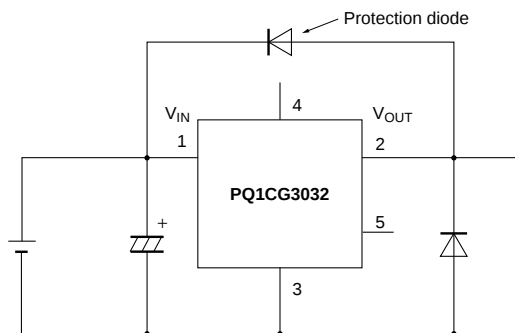
For minimizing inductance, it is recommended to design the thick and short pattern (between large current diodes, input/output capacitors, and terminal 1,2.) Single-point grounding (as indicated) should be used for best results.

- (2) High switching speed and low forward voltage type schottky barrier diode should be recommended for the catch-diode D because it affects the efficiency. Please select the diode which the current rating is at least 1.2 times greater than maximum switching current.

- (3) The output ripple voltage is highly influenced by ESR (Equivalent Series Resistor) of output capacitor, and can be minimized by selecting Low ESR capacitor.

- (4) An inductor should not be operated beyond its maximum rated current so that it may not saturate.

- (5) When voltage that is higher than V_{IN} ①, is applied to V_{OUT} ②, there is the case that the device is broken. Especially, in case V_{IN} ① is shorted to GND in normal condition, there is the case that the device is broken since the charged electric charge in output capacitor (C_O) flows into input side. In such case a schottky barrier diode or a silicon diode shall be recommended to connect as the following circuit.



■ ON/OFF Control Terminal

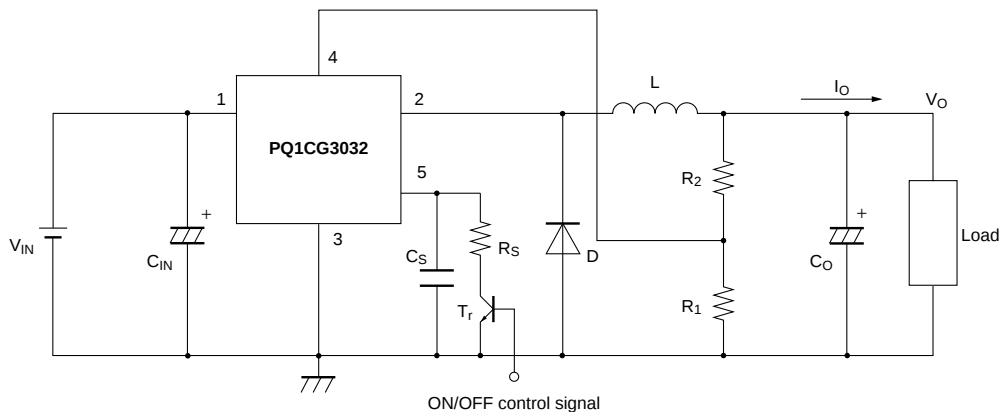
1. In the following circuit, when ON/OFF control terminal ⑤ becomes low by switching transistor T_r on, output voltage may be turned OFF and the device becomes stand-by mode. Dissipation current at stand-by mode becomes Max.400 μ A.

2. Soft start

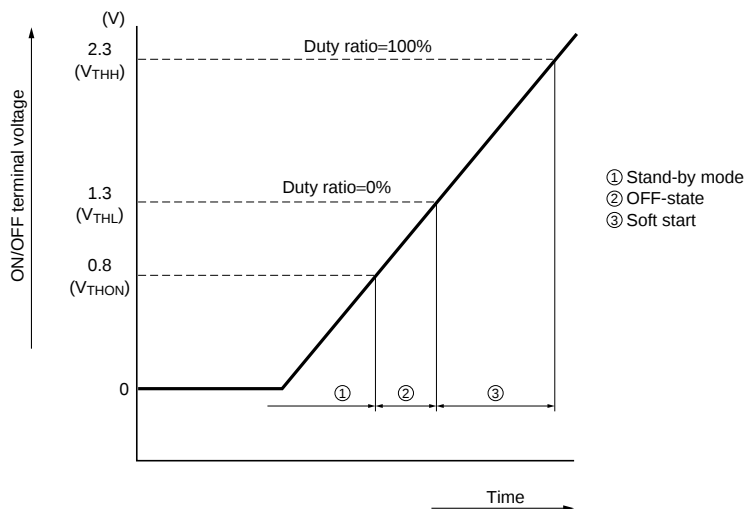
When capacitor C_s is attached, output pulse gradually expanded and output voltage will start softly.

3. ON/OFF control with soft startup

For ON/OFF control with capacitor C_s , be careful not to destroy a transistor T_r by discharge current from C_s , adding a resistor restricting discharge current of C_s .



■ ON-OFF Terminal Voltage vs. Time



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